## NGTB40N135IHRWG

## IGBT with Monolithic Free <br> Wheeling Diode

This Insulated Gate Bipolar Transistor (IGBT) features a robust and cost effective Field Stop (FS) Trench construction, and provides superior performance in demanding switching applications, offering both low on-state voltage and minimal switching loss. The IGBT is well suited for resonant or soft switching applications.

## Features

- Extremely Efficient Trench with Fieldstop Technology
- 1350 V Breakdown Voltage
- Optimized for Low Losses in IH Cooker Application
- Reliable and Cost Effective Single Die Solution
- These are $\mathrm{Pb}-$ Free Devices


## Typical Applications

- Inductive Heating
- Consumer Appliances
- Soft Switching


## ABSOLUTE MAXIMUM RATINGS

| Rating | Symbol | Value | Unit |
| :---: | :---: | :---: | :---: |
| Collector-emitter voltage | $\mathrm{V}_{\text {CES }}$ | 1350 | V |
| Collector current <br> @ Tc $=25^{\circ} \mathrm{C}$ <br> @ $\mathrm{Tc}=100^{\circ} \mathrm{C}$ | I | $\begin{aligned} & 80 \\ & 40 \end{aligned}$ | A |
| Pulsed collector current, $\mathrm{T}_{\text {pulse }}$ limited by $\mathrm{T}_{\mathrm{Jmax}}, 10 \mu \mathrm{~s}$ Pulse, $V_{G E}=15 \mathrm{~V}$ | $\mathrm{I}_{\text {CM }}$ | 120 | A |
| Diode forward current <br> @ Tc $=25^{\circ} \mathrm{C}$ <br> @ $\mathrm{Tc}=100^{\circ} \mathrm{C}$ | $\mathrm{I}_{\text {F }}$ | $\begin{aligned} & 80 \\ & 40 \end{aligned}$ | A |
| Diode pulsed current, $\mathrm{T}_{\text {pulse }}$ limited by $\mathrm{T}_{\mathrm{Jmax}}, 10 \mu \mathrm{~s}$ Pulse, $\mathrm{V}_{\mathrm{GE}}=0 \mathrm{~V}$ | $\mathrm{I}_{\mathrm{FM}}$ | 120 | A |
| Gate-emitter voltage Transient Gate-emitter Voltage ( $\mathrm{T}_{\text {pulse }}=5 \mu \mathrm{~s}, \mathrm{D}<0.10$ ) | $\mathrm{V}_{\mathrm{GE}}$ | $\begin{aligned} & \pm 20 \\ & \pm 25 \end{aligned}$ | V |
| Power Dissipation <br> @ $\mathrm{Tc}=25^{\circ} \mathrm{C}$ <br> @ $\mathrm{Tc}=100^{\circ} \mathrm{C}$ | $\mathrm{P}_{\mathrm{D}}$ | $\begin{aligned} & 394 \\ & 197 \end{aligned}$ | W |
| Operating junction temperature range | $\mathrm{T}_{\mathrm{J}}$ | -40 to +175 | ${ }^{\circ} \mathrm{C}$ |
| Storage temperature range | $\mathrm{T}_{\text {stg }}$ | -55 to +175 | ${ }^{\circ} \mathrm{C}$ |
| Lead temperature for soldering, $1 / 8^{\prime \prime}$ from case for 5 seconds | $\mathrm{T}_{\text {SLD }}$ | 260 | ${ }^{\circ} \mathrm{C}$ |

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.


## ON Semiconductor ${ }^{\circledR}$

http://onsemi.com
$40 \mathrm{~A}, 1350 \mathrm{~V}$
$\mathrm{~V}_{\text {CEsat }}=2.40 \mathrm{~V}$
$E_{\text {off }}=1.30 \mathrm{~mJ}$


MARKING DIAGRAM


A = Assembly Location
Y = Year
WW = Work Week
$\mathrm{G} \quad=\mathrm{Pb}-$ Free Package

## ORDERING INFORMATION

| Device | Package | Shipping |
| :---: | :---: | :---: |
| NGTB40N135IHRWG | TO-247 <br> (Pb-Free) | 30 Units / Rail |

THERMAL CHARACTERISTICS

| Rating | Symbol | Value | Unit |
| :--- | :---: | :---: | :---: |
| Thermal resistance junction-to-case | $\mathrm{R}_{\theta \mathrm{JC}}$ | 0.385 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| Thermal resistance junction-to-ambient | $\mathrm{R}_{\theta \mathrm{JA}}$ | 40 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |

ELECTRICAL CHARACTERISTICS $\left(\mathrm{T}_{\mathrm{J}}=25^{\circ} \mathrm{C}\right.$ unless otherwise specified)

| Parameter | Test Conditions | Symbol | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| STATIC CHARACTERISTIC |  |  |  |  |  |  |
| Collector-emitter breakdown voltage, gate-emitter short-circuited | $\mathrm{V}_{\mathrm{GE}}=0 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=500 \mu \mathrm{~A}$ | $V_{\text {(BR) }}$ CES | 1350 | - | - | V |
| Collector-emitter saturation voltage | $\begin{gathered} \mathrm{V}_{\mathrm{GE}}=15 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=40 \mathrm{~A} \\ \mathrm{~V}_{\mathrm{GE}}=15 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=40 \mathrm{~A}, \mathrm{~T}_{\mathrm{J}}=175^{\circ} \mathrm{C} \end{gathered}$ | $\mathrm{V}_{\text {CEsat }}$ | - | $\begin{aligned} & 2.40 \\ & 2.80 \end{aligned}$ | $2.70$ | V |
| Gate-emitter threshold voltage | $\mathrm{V}_{\mathrm{GE}}=\mathrm{V}_{\mathrm{CE}}, \mathrm{I}_{\mathrm{C}}=250 \mu \mathrm{~A}$ | $\mathrm{V}_{\mathrm{GE} \text { (th) }}$ | 4.5 | 5.5 | 6.5 | V |
| Collector-emitter cut-off current, gateemitter short-circuited | $\begin{gathered} \mathrm{V}_{\mathrm{GE}}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{CE}}=1350 \mathrm{~V} \\ \mathrm{~V}_{\mathrm{GE}}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{CE}}=1350 \mathrm{~V}, \mathrm{~T}_{\mathrm{J}}=175^{\circ} \mathrm{C} \end{gathered}$ | $I_{\text {CES }}$ | - | - | $\begin{aligned} & 0.5 \\ & 2.0 \end{aligned}$ | mA |
| Gate leakage current, collector-emitter short-circuited | $\mathrm{V}_{\mathrm{GE}}=20 \mathrm{~V}, \mathrm{~V}_{\mathrm{CE}}=0 \mathrm{~V}$ | $I_{\text {GES }}$ | - | - | 100 | nA |

DYNAMIC CHARACTERISTIC

| Input capacitance | $\mathrm{V}_{\mathrm{CE}}=20 \mathrm{~V}, \mathrm{~V}_{\mathrm{GE}}=0 \mathrm{~V}, \mathrm{f}=1 \mathrm{MHz}$ | $\mathrm{C}_{\text {ies }}$ | - | 5290 | - | pF |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Output capacitance |  | Coes | - | 124 | - |  |
| Reverse transfer capacitance |  | $\mathrm{C}_{\text {res }}$ | - | 100 | - |  |
| Gate charge total | $\mathrm{V}_{\mathrm{CE}}=600 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=40 \mathrm{~A}, \mathrm{~V}_{\mathrm{GE}}=15 \mathrm{~V}$ | $\mathrm{Q}_{\mathrm{g}}$ | - | 234 | - | nC |
| Gate to emitter charge |  | $\mathrm{Q}_{\mathrm{ge}}$ | - | 39 | - |  |
| Gate to collector charge |  | $\mathrm{Q}_{\mathrm{gc}}$ | - | 105 | - |  |

SWITCHING CHARACTERISTIC, INDUCTIVE LOAD

| Turn-off delay time | $\begin{gathered} \mathrm{T}_{J}=25^{\circ} \mathrm{C} \\ \mathrm{~V}_{\mathrm{CC}}=600 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=40 \mathrm{~A} \\ \mathrm{R}_{\mathrm{g}}=10 \Omega \\ \mathrm{~V}_{\mathrm{GE}}=0 \mathrm{~V} / 15 \mathrm{~V} \end{gathered}$ | $\mathrm{t}_{\mathrm{d} \text { (off) }}$ | - | 250 | - | ns |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Fall time |  | $\mathrm{t}_{\mathrm{f}}$ | - | 130 | - |  |
| Turn-off switching loss |  | $\mathrm{E}_{\text {off }}$ | - | 1.30 | - | mJ |
| Turn-off delay time | $\begin{gathered} \mathrm{T}_{J}=150^{\circ} \mathrm{C} \\ \mathrm{~V}_{\mathrm{CC}}=600 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=40 \mathrm{~A} \\ \mathrm{R}_{\mathrm{g}}=10 \Omega \\ \mathrm{~V}_{\mathrm{GE}}=0 \mathrm{~V} / 15 \mathrm{~V} \end{gathered}$ | $\mathrm{t}_{\mathrm{d} \text { (off) }}$ | - | 260 | - | ns |
| Fall time |  | $\mathrm{t}_{\mathrm{f}}$ | - | 190 | - |  |
| Turn-off switching loss |  | $\mathrm{E}_{\text {off }}$ | - | 2.60 | - | mJ |

DIODE CHARACTERISTIC

| Forward voltage | $\mathrm{V}_{\mathrm{GE}}=0 \mathrm{~V}, \mathrm{I}_{\mathrm{F}}=40 \mathrm{~A}$ | $\mathrm{~V}_{\mathrm{F}}$ | - | 2.30 | 2.70 |
| :--- | :---: | :---: | :---: | :---: | :---: |
|  | $\mathrm{~V}_{\mathrm{GE}}=0 \mathrm{~V}, \mathrm{I}_{\mathrm{F}}=40 \mathrm{~A}, \mathrm{~T}_{\mathrm{J}}=175^{\circ} \mathrm{C}$ | V |  |  |  |

## NGTB40N135IHRWG

TYPICAL CHARACTERISTICS


Figure 1. Output Characteristics


Figure 3. Output Characteristics


Figure 5. $\mathbf{V}_{\text {CE(sat) }}$ vs. $\mathrm{T}_{\mathbf{J}}$


Figure 2. Output Characteristics


Figure 4. Typical Transfer Characteristics


Figure 6. Typical Capacitance

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TYPICAL CHARACTERISTICS


Figure 7. Diode Forward Characteristics


Figure 9. Switching Loss vs. Temperature

Figure 11. Switching Loss vs. IC


Figure 8. Typical Gate Charge


Figure 10. Switching Time vs. Temperature


Figure 12. Switching Time vs. IC

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## TYPICAL CHARACTERISTICS



Figure 13. Switching Loss vs. $\mathbf{R g}_{\mathbf{g}}$


Figure 15. Switching Loss vs. $\mathrm{V}_{\mathrm{CE}}$


Figure 17. Safe Operating Area


Figure 14. Switching Time vs. $\mathbf{R g}_{\mathbf{g}}$


Figure 16. Switching Time vs. $\mathrm{V}_{\mathrm{CE}}$


Figure 18. Reverse Bias Safe Operating Area

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TYPICAL CHARACTERISTICS


Figure 19. Collector Current vs. Switching Frequency


Figure 20. Typical $\mathbf{V}_{\text {(BR)CEs }}$ vs. Temperature


Figure 21. IGBT Transient Thermal Impedance

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Figure 22. Test Circuit for Switching Characteristics

## NGTB40N135IHRWG



Figure 23. Definition of Turn On Waveform

## NGTB40N135IHRWG



Figure 24. Definition of Turn Off Waveform


NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. SLOT REQUIRED, NOTCH MAY BE ROUNDED.
4. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH. MOLD FLASH SHALL NOT EXCEED 0.13 PER SIDE. THESE DIMENSIONS ARE MEASURED AT THE OUTERMOST EXTREME OF THE PLASTIC BODY.
5. LEAD FINISH IS UNCONTROLLED IN THE REGION DEFINED BY L1.
6. $\varnothing$ P SHALL HAVE A MAXIMUM DRAFT ANGLE OF $1.5^{\circ}$ TO THE TOP OF THE PART WITH A MAXIMUM DIAMETER OF 3.91 .
7. DIMENSION A1 TO BE MEASURED IN THE REGION DEFINED
DIMENSION A1 TO BE ME
BYL1.

|  | MILLIMETERS |  |
| :---: | :---: | :---: |
| DIM | MIN | MAX |
| A | 4.70 | 5.30 |
| A1 | 2.20 | 2.60 |
| b | 1.07 | 1.33 |
| b2 | 1.65 | 2.35 |
| b4 | 2.60 | 3.40 |
| c | 0.45 | 0.68 |
| D | 20.80 | 21.34 |
| E | 15.50 | 16.25 |
| E2 | 4.32 | 5.49 |
| e | 5.45 | BSC |
| F | 2.655 | --- |
| L | 19.80 | 20.80 |
| L1 | 3.81 | 4.32 |
| P | 3.55 | 3.65 |
| Q | 5.40 | 6.20 |
| S | 6.15 BSC |  |

GENERIC
MARKING DIAGRAM*


XXXXX = Specific Device Code
A = Assembly Location
Y = Year
WW = Work Week
$\mathrm{G} \quad=\mathrm{Pb}$-Free Package
*This information is generic. Please refer to device data sheet for actual part marking.
Pb-Free indicator, "G" or microdot " $\quad$ ", may or may not be present.

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IXA40RG1200DHGLB APT70GR65B2DU40 NTE3320 IHFW40N65R5SXKSA1 APT70GR120J APT35GP120JDQ2
IKZA40N65RH5XKSA1 IKFW75N65ES5XKSA1 IKFW50N65ES5XKSA1 IKFW50N65EH5XKSA1 IKFW40N65ES5XKSA1 IKFW60N65ES5XKSA1 IMBG120R090M1HXTMA1 IMBG120R220M1HXTMA1 XD15H120CX1 XD25H120CX0 XP15PJS120CL1B1 IGW30N60H3FKSA1 STGWA8M120DF3 IGW08T120FKSA1 IGW75N60H3FKSA1 HGTG40N60B3 FGH60N60SMD_F085

FGH75T65UPD STGWA15H120F2 IKA10N60TXKSA1 IHW20N120R5XKSA1 RJH60D2DPP-M0\#T2 IKP20N60TXKSA1 IHW20N65R5XKSA1 IDW40E65D2FKSA1

